# AMOLED Manufacturing Process Report

Ver. 2

2019



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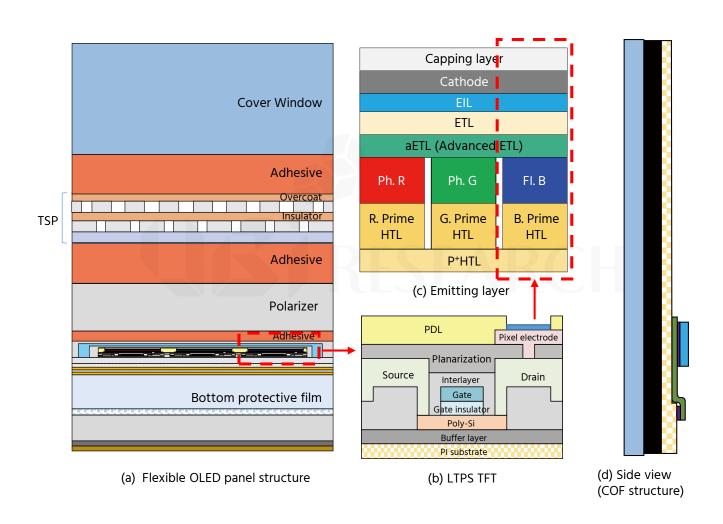
## 1. AMOLED Structure

#### 1.1 Mobile device panel structure

#### Mobile flexible OLED panel\_add on TSP

- The structure of mobile flexible OLED is generally similar to that of small and medium rigid OLEDs (TFT, polarizer, and cover window).
- · Substrate changed from glass to PI, encapsulation changed from Frit to TFE (thin film encapsulation) method..
- · Add-on TSP is a type of attaching a touch screen panel film on a polarizer.
- Driver IC of mobile flexible OLED is connected by FPCB, and attached by COF (chip on film) or COP (chip on plastic) method using ACF.

#### Structure for mobile flexible OLED panel \_add on TSP

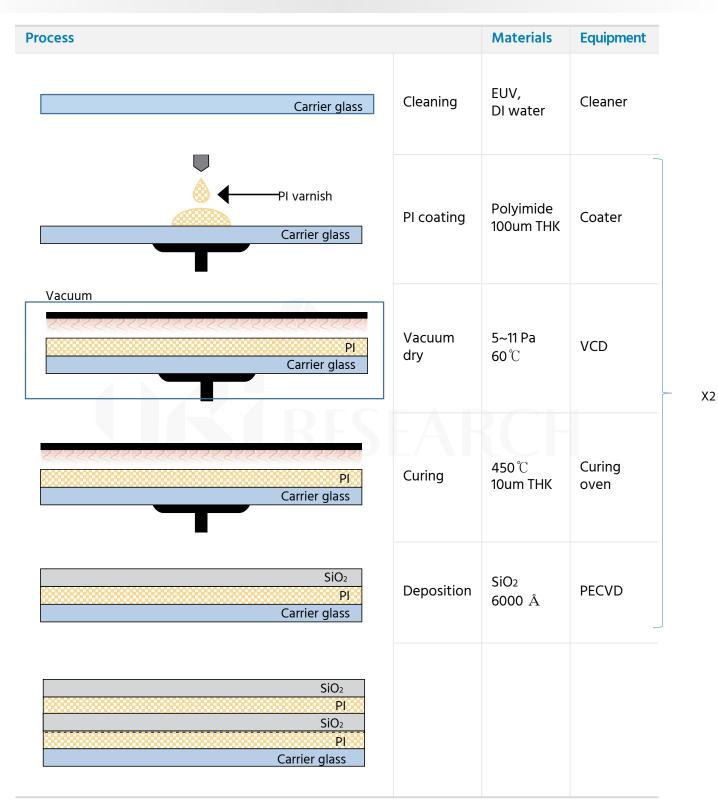


# 2. TFT Manufacturing Process

### 2.2 LTPS TFT basic manufacturing process

· Flexible substrate

#### LTPS TFT manufacturing process and equipment

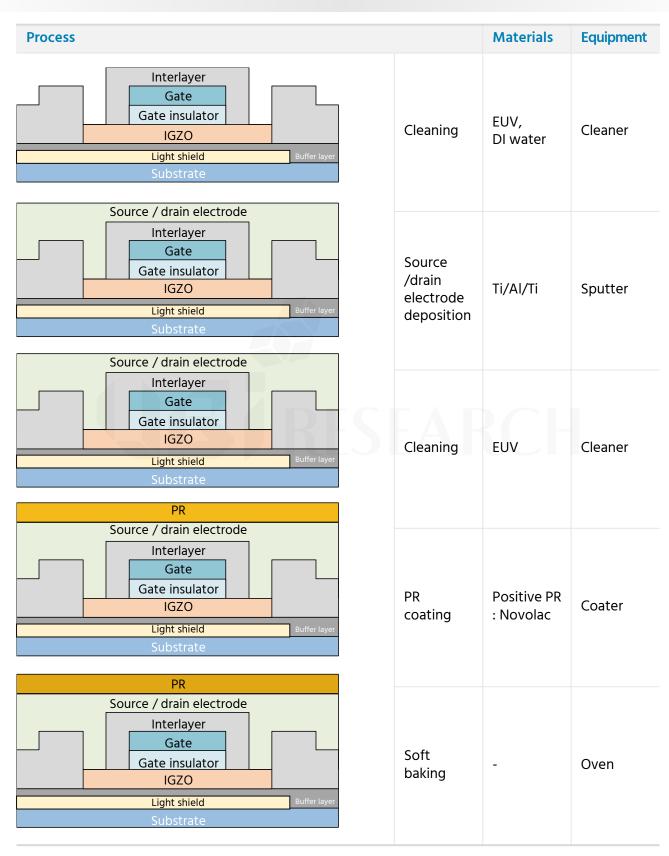


# 2. TFT Manufacturing Process

### 2.5 LG OLEDTV's Oxide TFT manufacturing process

· Source/drain electrode deposition

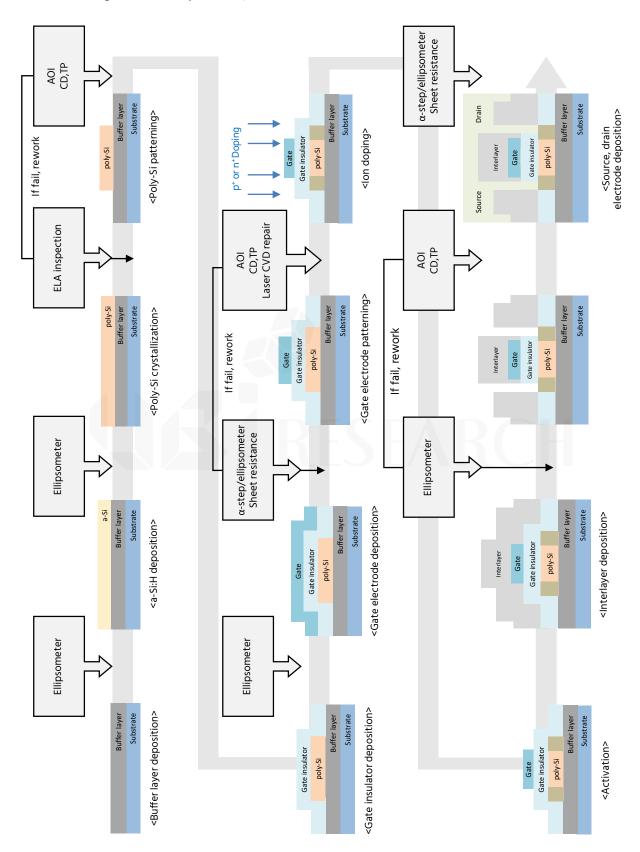
#### Oxide TFT manufacturing process and equipment



# 2. TFT Manufacturing Process

### 2.6 TFT inspection and measurement process

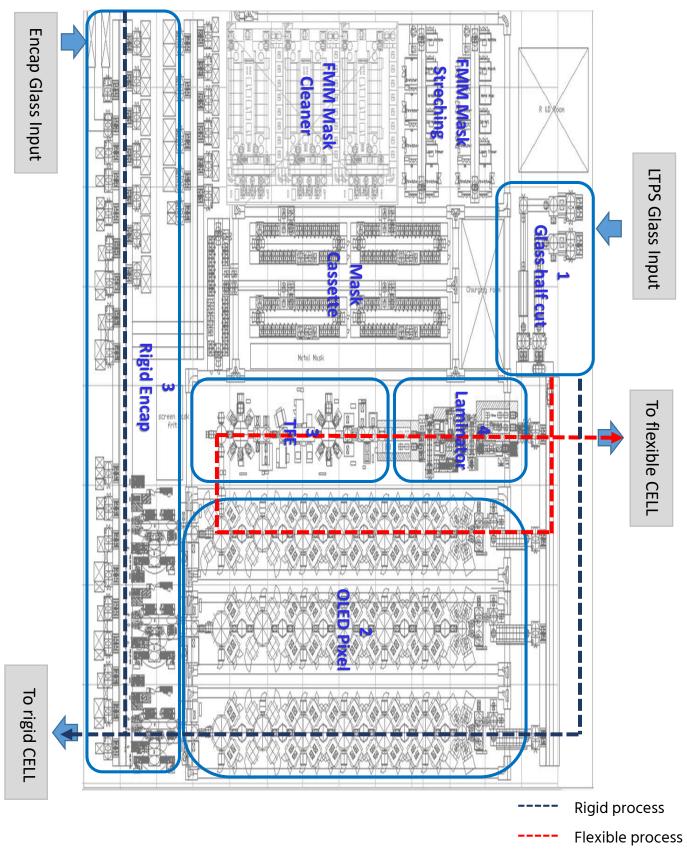
 $\cdot$  During TFT process,  $\alpha$ -step and ellipsometer are used to measure the thickness, AOI equipment to inspect the pattern, and laser CVD equipment to repair the TFT by detecting defects of signal line, respectively.



# 3. OLED Pixel and Encapsulation Manufacturing Process

### 3.1 OLED Pixel and Encapsulation manufacturing equipment layout

#### **OLED Pixel and Encapsulation layout example**

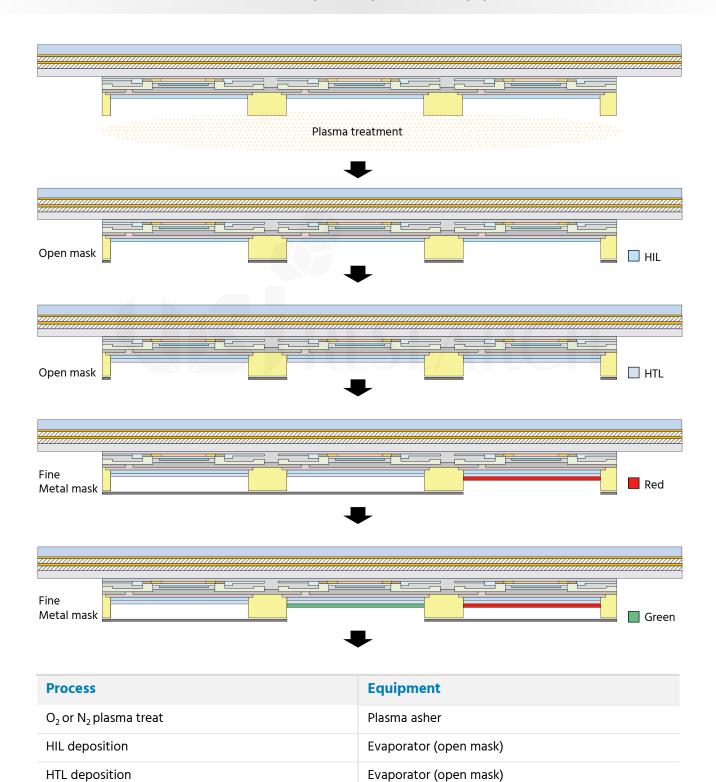


# 3. OLED Pixel and Encapsulation Manufacturing Process

### 3.2 Mobile Rigid OLED manufacturing process

### **OLED Pixel process**

#### **RGB OLED Pixel deposition process and equipment**



Evaporator (FMM)

Evaporator (FMM)

Red OLED deposition

Green OLED deposition